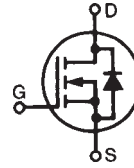


# PolarHV™ HiPerFET Power MOSFETs

**IXFH 22N60P**  
**IXFV 22N60P**  
**IXFV 22N60PS**

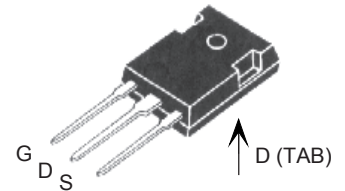
$V_{DSS} = 600 \text{ V}$   
 $I_{D25} = 22 \text{ A}$   
 $R_{DS(on)} \leq 350 \text{ m}\Omega$   
 $t_{rr} \leq 200 \text{ ns}$

N-Channel Enhancement Mode  
Fast Intrinsic Diode  
Avalanche Rated

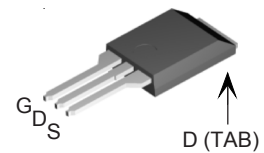


| Symbol        | Test Conditions   | Maximum Ratings |                  |
|---------------|---|-----------------|------------------|
| $V_{DSS}$     | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$   | 600             | V                |
| $V_{DGR}$     | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GS} = 1 \text{ M}\Omega$  | 600             | V                |
| $V_{GS}$      | Continuous  | $\pm 30$        | V                |
| $V_{GSM}$     | Transient   | $\pm 40$        | V                |
| $I_{D25}$     | $T_C = 25^\circ\text{C}$  | 22              | A                |
| $I_{DM}$      | $T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$  | 66              | A                |
| $I_{AR}$      | $T_C = 25^\circ\text{C}$  | 22              | A                |
| $E_{AR}$      | $T_C = 25^\circ\text{C}$  | 40              | mJ               |
| $E_{AS}$      | $T_C = 25^\circ\text{C}$  | 1.0             | J                |
| $dv/dt$       | $I_S \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$<br>$T_J \leq 150^\circ\text{C}$ , $R_G = 4 \Omega$ | 20              | V/ns             |
| $P_D$         | $T_C = 25^\circ\text{C}$  | 400             | W                |
| $T_J$         |   | -55 ... +150    | $^\circ\text{C}$ |
| $T_{JM}$      |   | 150             | $^\circ\text{C}$ |
| $T_{stg}$     |   | -55 ... +150    | $^\circ\text{C}$ |
| $T_L$         | 1.6 mm (0.062 in.) from case for 10 s   | 300             | $^\circ\text{C}$ |
| $T_{SOLD}$    | Plastic body for 10 s   | 260             | $^\circ\text{C}$ |
| $M_d$         | Mounting torque (TO-247)  | 1.13/10         | Nm/lb.in.        |
| $F_C$         | Mounting Force (PLUS220)  | 11..65/2.5..15  | Nm/lb.           |
| <b>Weight</b> | TO-247  | 6               | g                |
|               | PLUS220 & PLUS220SMD  | 4               | g                |

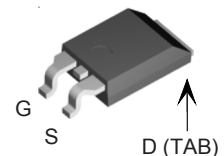
TO-247 (IXFH)



PLUS220 (IXFV)



PLUS220SMD (IXFV...S)



G = Gate      D = Drain  
S = Source    TAB = Drain

| Symbol       | Test Conditions<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified)                                      | Characteristic Values |      |                                       |
|--------------|--|-----------------------|------|---------------------------------------|
|              |  | Min.                  | Typ. | Max.                                  |
| $BV_{DSS}$   | $V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$   | 600                   |      | V                                     |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$ , $I_D = 4 \text{ mA}$   | 3.0                   |      | 5.5 V                                 |
| $I_{GSS}$    | $V_{GS} = \pm 30 \text{ V}_{DC}$ , $V_{DS} = 0$  |                       |      | $\pm 100 \text{ nA}$                  |
| $I_{DSS}$    | $V_{DS} = V_{DSS}$<br>$V_{GS} = 0 \text{ V}$ $T_J = 125^\circ\text{C}$   |                       |      | 25 $\mu\text{A}$<br>250 $\mu\text{A}$ |
| $R_{DS(on)}$ | $V_{GS} = 10 \text{ V}$ , $I_D = 0.5 I_{D25}$<br>Pulse test, $t \leq 300 \mu\text{s}$ , duty cycle $d \leq 2 \%$ |                       |      | 350 $\text{m}\Omega$                  |

## Features

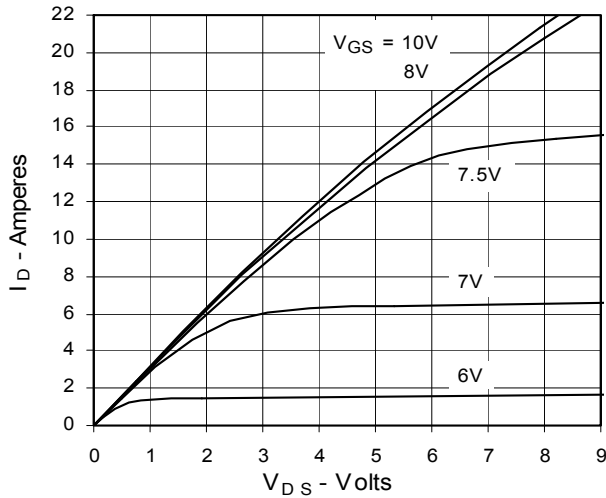
- † Fast intrinsic diode
- † Unclamped Inductive Switching (UIS) rated
- † International standard packages
- † Low package inductance
- easy to drive and to protect

## Advantages

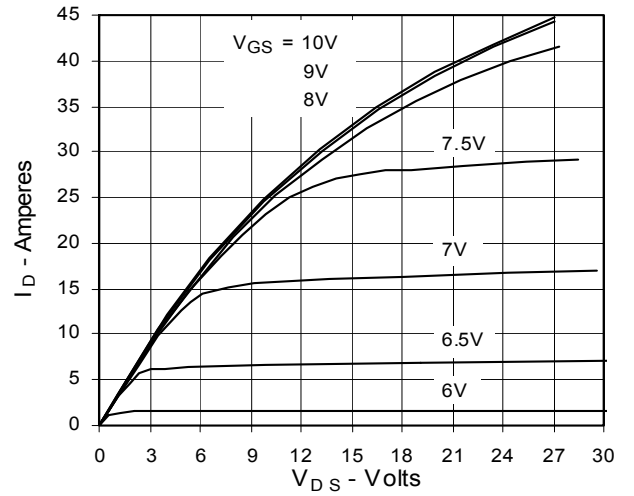
- † Easy to mount
- † Space savings
- † High power density



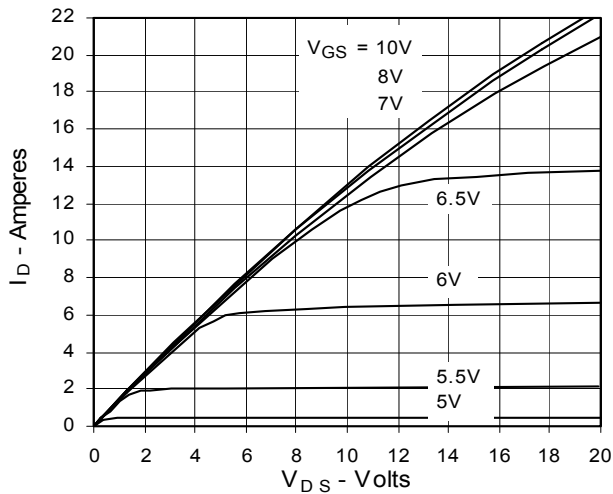
**Fig. 1. Output Characteristics  
@ 25°C**



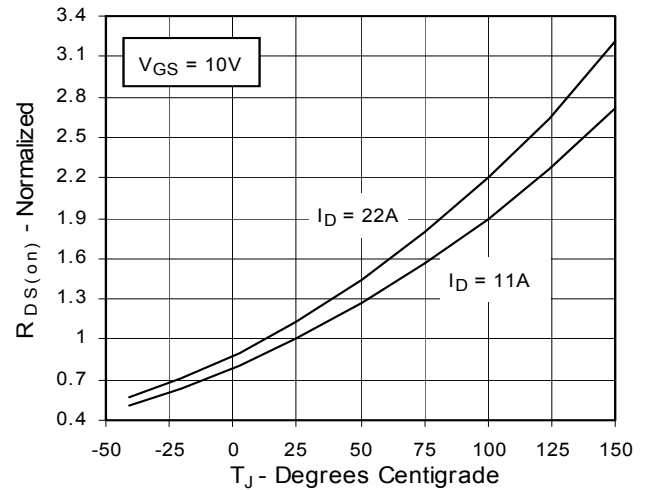
**Fig. 2. Extended Output Characteristics  
@ 25°C**



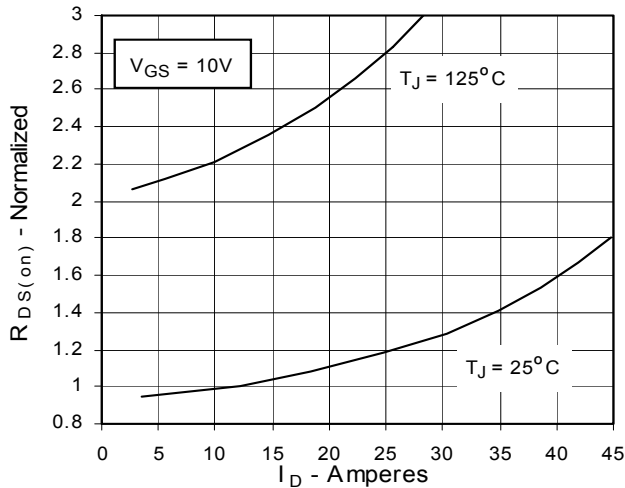
**Fig. 3. Output Characteristics  
@ 125°C**



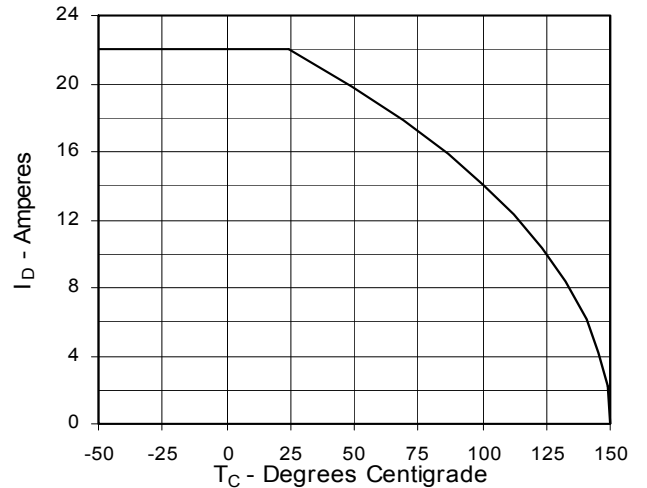
**Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D = 11\text{A}$   
Value vs. Junction Temperature**



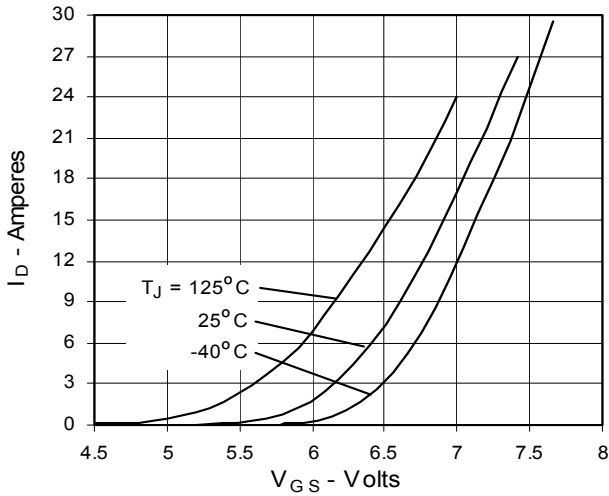
**Fig. 5.  $R_{DS(on)}$  Normalized to  
 $I_D = 11\text{A}$  Value vs. Drain Current**



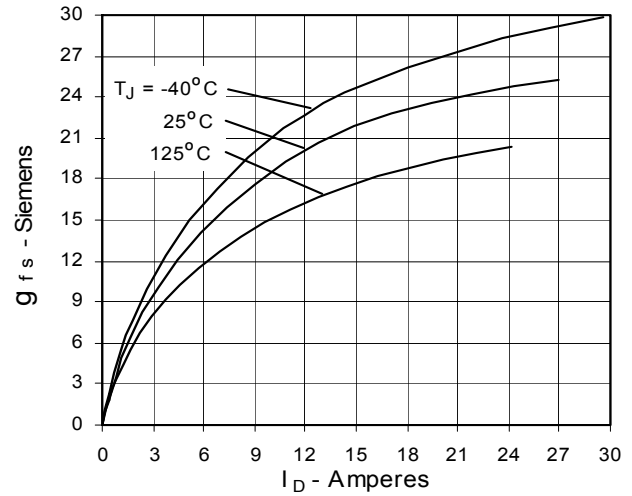
**Fig. 6. Drain Current vs. Case  
Temperature**



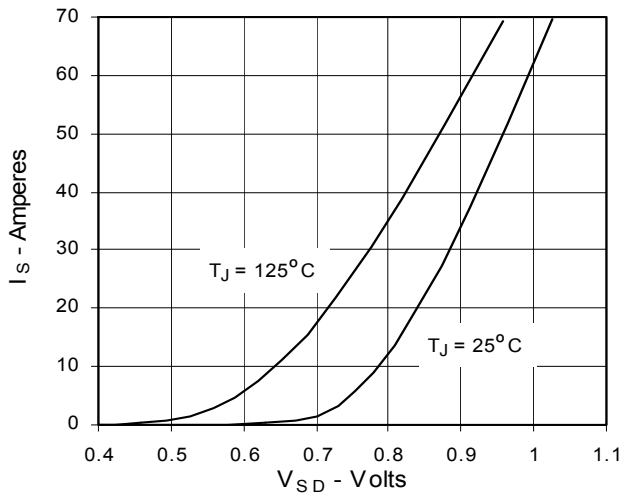
**Fig. 7. Input Admittance**



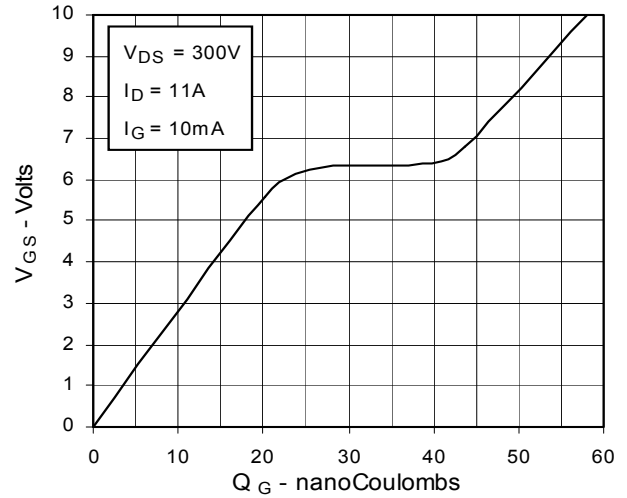
**Fig. 8. Transconductance**



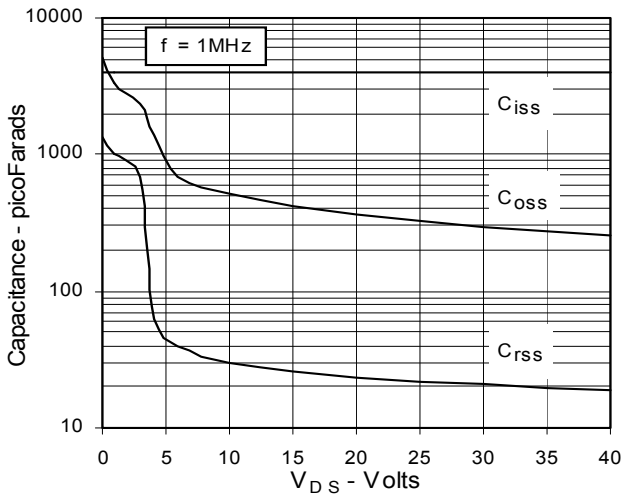
**Fig. 9. Source Current vs. Source-To-Drain Voltage**



**Fig. 10. Gate Charge**



**Fig. 11. Capacitance**



**Fig. 12. Forward-Bias Safe Operating Area**

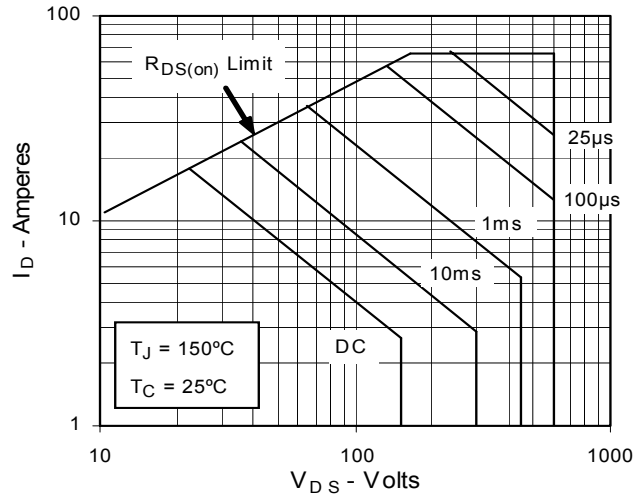
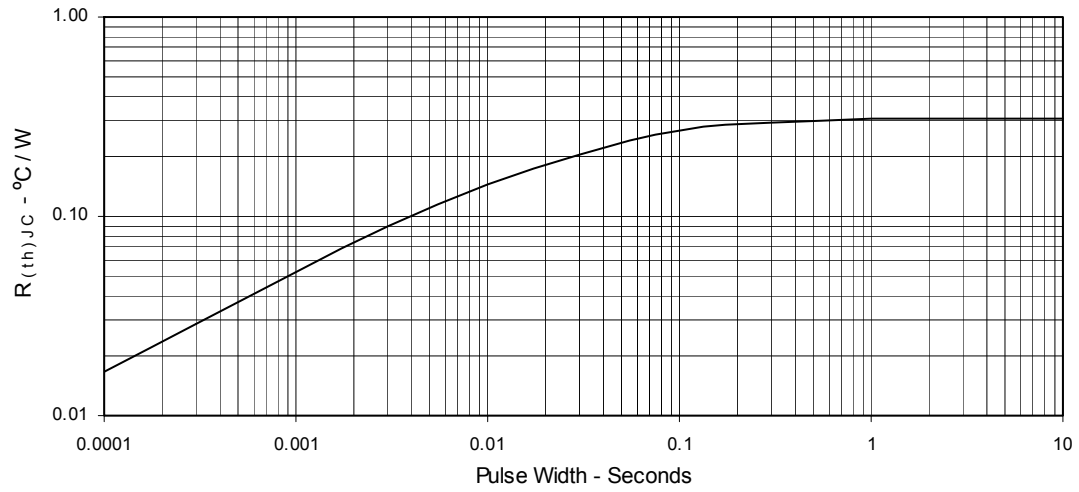


Fig. 13. Maximum Transient Thermal Resistance





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